# **SWITCHMODE** <sup>™</sup> **Power Rectifier**

The MBR2535CTL employs the Schottky Barrier principle in a large metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use in low voltage, high frequency switching power supplies, free wheeling diodes, and polarity protection diodes.

## **Features**

- Very Low Forward Voltage (0.55 V Maximum @ 25 Amps)
- Matched Dual Die Construction (12.5 A per Leg or 25 A per Package)
- Guardring for Stress Protection
- Highly Stable Oxide Passivated Junction (125°C Operating Junction Temperature)
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Shipped 50 units per plastic tube
- Pb-Free Packages are Available\*

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

#### MAXIMUM RATINGS (Per Leg)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	35	V
Average Rectified Forward Current (Rated V <sub>R</sub> , T <sub>C</sub> = 110°C)	I <sub>F(AV)</sub>	12.5	Α
Peak Repetitive Forward Current, per Leg (Rated $V_R$ , Sq Wave, 20 kHz, $T_C = 95^{\circ}C$ )	I <sub>FRM</sub>	25	Α
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions, Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	150	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	1.0	Α
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C
Operating Junction Temperature	TJ	-65 to +125	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000	V/μs
Controlled Avalanche Energy	W <sub>aval</sub>	20	mJ

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

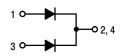
\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



## ON Semiconductor®

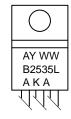
http://onsemi.com

# SCHOTTKY BARRIER RECTIFIER 25 AMPERES, 35 VOLTS





#### MARKING DIAGRAM



A = Assembly Location

Y = Year WW = Work Week

B2535L = Device Code AKA = Polarity Designator

## **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MBR2535CTL	TO-220	50 Units/Rail
MBR2535CTLG	TO-220 (Pb-Free)	50 Units/Rail

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	2.0	°C/W

## **ELECTRICAL CHARACTERISTICS** (Per Leg)

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (Note 1) ( $I_F = 25 \text{ Amps}, T_J = 25^{\circ}\text{C}$ ) ( $I_F = 12.5 \text{ Amps}, T_J = 25^{\circ}\text{C}$ ) ( $I_F = 12.5 \text{ Amps}, T_J = 125^{\circ}\text{C}$ )	V <sub>F</sub>	0.55 0.47 0.41	٧
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 125^{\circ}C$ )	I <sub>R</sub>	5.0 500	mA

<sup>1.</sup> Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

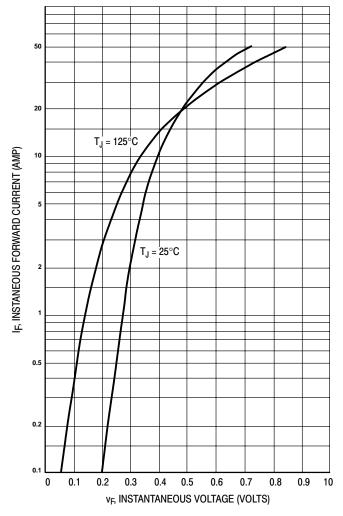


Figure 1. Typical Forward Voltage, Per Leg

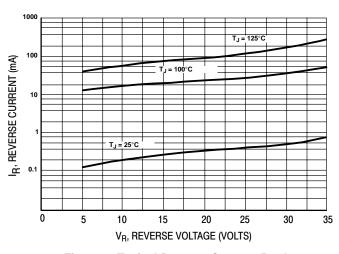


Figure 2. Typical Reverse Current, Per Leg

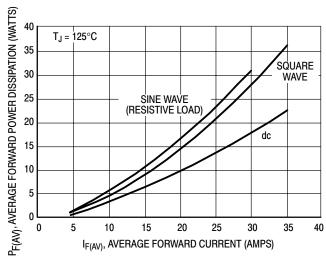


Figure 3. Forward Power Dissipation, Per Leg

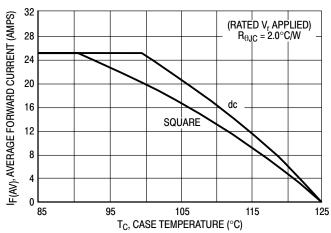


Figure 4. Current Derating

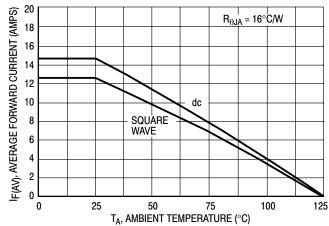
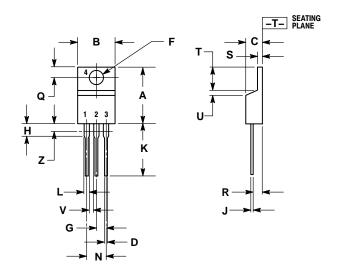


Figure 5. Current Derating Ambient, Per Leg

## **PACKAGE DIMENSIONS**

TO-220 PLASTIC CASE 221A-09 ISSUE AA



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
  V14 5M 1092
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.
- DIMENSION 2 DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04

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